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# Enthalpies of mixing of liquid systems for lead free soldering: Al–Cu–Sn system

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# ABSTRACT

The present work refers to high-temperature drop calorimetric measurements on liquid Al–Cu, Al–Sn, and Al–Cu–Sn alloys. The binary systems have been investigated at 973 K, up to 40 at.% Cu in case of Al–Cu, and over the entire concentrational range in case of Al–Sn. Measurements in the ternary Al– Cu–Sn system were performed along the following cross-sections:  $x_{Al}/x_{Cu} = 1:1$ ,  $x_{Al}/x_{Sn} = 1:1$ ,  $x_{Cu}/x_{Cu} = 1:1$  $x_{\text{Sn}}$  = 7:3,  $x_{\text{Cu}}/x_{\text{Sn}}$  = 1:1, and  $x_{\text{Cu}}/x_{\text{Sn}}$  = 3:7 at 1273 K. Experimental data were used to find ternary interaction parameters by applying the Redlich–Kister–Muggianu model for substitutional solutions, and a full set of parameters describing the concentration dependence of the enthalpy of mixing was derived. From these, the isoenthalpy curves were constructed for 1273 K. The ternary system shows an exothermic enthalpy minimum of approx.  $-18,000$  J/mol in the Al–Cu binary and a maximum of approx.  $4000$  J/ mol in the Al–Sn binary system. The Al–Cu–Sn system is characterized by considerable repulsive ternary interactions as shown by the positive ternary interaction parameters.

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# 1. Introduction

Since soft solders with lead had to be replaced by new materials which are safe for the environment the search for lead-free solders has started in Europe several years ago. Whereas several suitable replacements have been developed for low temperature soft soldering there is still a lack of lead-free solders applicable at higher temperatures  $\{240 \text{ to } 350\text{-} \text{°C}\}\$ . Among the potential new materials are systems based on Cu–Sn alloys, whereas Cu is also a frequently used contact material. Al is under discussion as an additive in order to enhance the melting temperature of the solder. Moreover, Al electrodes with thin layers of Cu and Ni appear as contact materials in electronic soldering. To obtain the necessary knowledge on phase diagram and melting behavior of Al–Cu–Sn alloys, new experimental data are needed. Thermochemical measurements make an invaluable contribution to the understanding and calculation of phase equilibria, interfacial reactions and diffusion processes. Recently, thermodynamic data of Al–Cu–Sn from Knudsen effusion Mass Spectrometry (KEMS) have been published by Bencze et al. [\[1\]](#page-10-0). The aim of this work is a direct determination of the enthalpy of mixing of the liquid alloys and the comparison of these data to those derived from the KEMS measurements. In the literature one can find a number of results of calorimetric measurements in the binary systems Al–Cu, Al–Sn, and Cu–Sn, at various temperatures. They are summarized as follows:

## 1.1. Al–Cu system

Thermodynamic data for the binary system have been collected by Hultgren et al. [\[2\]](#page-10-0) and Predel [\[3\].](#page-10-0) The data given for the integral enthalpy of mixing of liquid alloys are based on the work of Yazawa and Itagaki [\[4\]](#page-10-0), who performed direct mixing calorimetry  $x_{Cu}$  = 0.11 to 0.90, at 1375 K. The minimum of the enthalpy was reported to be 10,200 J/mol at  $x_{Cu}$  = 0.62. In Hultgren et al. [\[2\]](#page-10-0) it was mentioned that there are two other experimental works available which give much more exothermic values [\[5,6\]](#page-10-0), with a minimum at approx.  $-23,000$  J/mol at 1473 K and  $-20,000$  J/mol at 1373 K, respectively. Later experiments from four different sources have been reviewed and assessed by Witusiewicz et al. [\[7\].](#page-10-0) These data are very consistent and show a minimum of approx.  $-17,500$  J mol at  $x_{Cu}$  = 0.62. A thermodynamic assessment for the Al–Cu system was published by Ansara et al. [\[8\]](#page-10-0), reproducing the values given by Witusiewicz et al. [\[7\].](#page-10-0)

## 1.2. Al–Sn system

This binary constituent system clearly shows endothermic mixing behavior of liquid alloys. Various experimental data have been collected and assessed by Hultgren et al. [\[2\].](#page-10-0)  $\Delta H$  shows a maximum



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<span id="page-1-0"></span>of approx. 4100 J/mol at  $x_{\text{Sn}}$  = 0.43. The direct reaction calorimetry done by Kawakami [\[5\]](#page-10-0) at 1073 K for  $x_{\rm Sn}$  = 0.20 to 0.76 resulted in a maximum of  $\Delta H$  of approx. 6520 J/mol at  $x_{\text{Sn}} = 0.4$ . A study of Schmiedl and Stofko [\[9\]](#page-10-0) yielded even more endothermic values with a maximum of approx. 7200 J/mol at  $x_{\text{Sn}} = 0.4$ . However, this value is based on an extrapolation of experimental values from a vapor pressure method for  $x_{Sn} = 0$  to 0.3. A thermodynamic assessment for the Al–Sn system was published by Ansara et al. [\[8\],](#page-10-0) reproducing the values given in Hultgren et al. [\[2\]](#page-10-0).

# 1.3. Cu–Sn system

The heat of mixing in the liquid binary Cu–Sn system was determined by several authors. Experimental values have been published by Kleppa et al. [\[10\],](#page-10-0) Takeuchi et al. [\[11\]](#page-10-0), Itagaki and Yazawa [\[4\],](#page-10-0) Iguchi et al. [\[12\]](#page-10-0), Pool et al. [\[13\],](#page-10-0) and Lee et al. [\[14\]](#page-10-0) measured  $\Delta_{\text{mix}}H$  at 723, 1363, 1373, 1393, 1440, and 997 K, respectively. Hultgren et al. summarized selected values of the integral enthalpies of mixing. Gierlotka et al. [\[15\]](#page-10-0) used a substitutional solution model to describe the liquid phase. By comparing the data of Itagaki and Yazawa [\[4\]](#page-10-0) at 1373 K and Lee et al. [\[14\]](#page-10-0) at 997 K, they suggested a temperature dependence of the enthalpy of mixing for liquid Cu–Sn alloys. Moreover, Flandorfer et al. [\[16\]](#page-10-0) measured the enthalpy of mixing of liquid Cu–Sn alloys at (773, 973, 1173, 1373, and 1523) K. The results were described by the Redlich– Kister model and also using an association model. The temperature dependence supposed by several authors before could be confirmed.

As far as the ternary Al–Cu–Sn system is concerned, there are only two thermodynamic studies by Bencze et al. [\[1\]](#page-10-0) and Miettinen [\[17\].](#page-10-0) Bencze et al. [\[1\]](#page-10-0) performed KEMS on the liquid ternary system whereas the latter author did a thermodynamic optimization of the copper-rich part of Al–Cu–Sn.

## 2. Experimental procedure

A Calvet-type twin micro-calorimeter HT 1000 (Setaram, Lyon, France) with two thermopiles consisting of more than 200 thermocouples each, a wire wound resistance furnace and an automatic drop device for up to 30 drops was used. Control of the entire equipment and data evaluation is performed with LabView and HiQ as described by Flandorfer et al. [\[18\]](#page-10-0). The measurements were performed under Ar-flow (approximately 30 ml/min). At the end of each series the calorimeter was calibrated by five additions (approximately 40 mg each) of NIST standard  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> (National Institute of Standards and Technology, Gaithersburg, MD).

Drop calorimetry in the binary systems Al–Cu and Al–Sn at 973 K. Pieces of Cu have been added to pure liquid Al or Al–Cu alloys up to approx. 40 at.% Cu where the formation of solid ( $\varepsilon$ phase) occurs. Three runs have been performed to check the reproducibility. Pieces of Sn have been added to pure liquid Al or Al–Sn alloys up to approx. 60 at% Sn and vice versa, Al to liquid Sn or Al– Sn alloys in the same way. Three runs have been performed in Al– Sn at all. In the ternary Al–Cu–Sn system heats of mixing have been measured along the five cross-sections  $x_{Al}/x_{Cu} = 1:1$ ,  $x_{Al}/x_{Sn} = 1:1$ ,  $x_{\text{Cu}}/x_{\text{Sn}} = 7:3$ ,  $x_{\text{Cu}}/x_{\text{Sn}} = 1:1$ , and  $x_{\text{Cu}}/x_{\text{Sn}} = 3:7$  at 1273 K, see also figure 1. Each section was measured twice in order to check the reproducibility. Starting materials for all experiments were Al rod (99.999%; Puratronic®, Alfa Aesar), Cu wire (99.98+%; Alfa Aesar), and Sn rod (99.9985%; Alfa Aesar). Al was surface cleaned by grinding, the Cu wire was treated under flowing  $H_2$  at 250 °C for 2 h to remove oxide layers and Sn was used without further purification.

Samples of pure metals (Al, Cu, or Sn) were introduced into a bath of liquid Al, Sn or binary alloys (Al–Cu, Al–Sn, or Cu–Sn) of chosen starting compositions (see figure 1). All measurements



FIGURE 1. Sections chosen for drop calorimetric measurements in the ternary Al-Cu–Sn system performed at 1273 K; concentrations given in mole fractions.

were carried out in a graphite crucible ( $\mathcal{O}_i$  = 9 mm, h = 90 mm) which was heated at 973 K for 10 min before using it to remove surface impurities.

The furnace temperature was set at (973 or 1273) K, respectively. The time interval between individual drops was usually 40 min. The obtained signals were recorded and integrated. The measured enthalpy (integrated heat flow at constant pressure) is

$$
\Delta H_{\text{drop}} = n_i (H_{\text{m},i,T_M} - H_{\text{m},i,T_D}) + \Delta H_{\text{Reaction}},
$$
\n(1)

where  $n_i$  is the number of moles of the added sample,  $H_m$  denotes molar enthalpies,  $T_D$  is the drop temperature, and  $T_M$  is the calorimeter temperature of the respective measurement in K. The molar enthalpy difference  $(H_{m,i,T_M} - H_{m,i,T_D)}$  was calculated using the SGTE database [\[19\]](#page-10-0). Because of the relatively small masses added, the partial enthalpies can be directly given as

$$
\Delta_{\text{mix}}\bar{H}_i = \Delta H_{\text{Reaction};i}/n_i. \tag{2}
$$

The integral enthalpy of mixing was calculated by summarizing the respective reaction enthalpies and division by the total molar amount of substance

$$
\Delta_{\text{mix}}H = \sum_{i} \Delta H_{\text{Reaction};i} / \left( n_{\text{crucible}} + \sum_{i} n_{\text{drop};i} \right). \tag{3}
$$

Random errors as well as systematic errors of calorimetry depend on the construction of the calorimeter, calibration procedure, signal integration and ''chemical errors'', e.g. incomplete reactions or impurities. Considering many calibration measurements done by dropping NIST standard sapphire, the standard deviation can be estimated to be less than ±1% for the HT-1000. The systematic errors are mainly caused by parasitic heat flows, base line problems at signal integration and dropping and mixing problems. One can estimate that the overall error is  $\pm 150$  J/mol.

## 3. Results and discussion

## 3.1. Experimental results

The enthalpy of mixing of liquid alloys of Al–Cu and Al–Sn has been measured because of somewhat ambiguous literature data as described in the introduction. The drop enthalpy ( $\Delta H_{\rm drop}$ ), the partial  $(\Delta_{\text{mix}}\overline{H_i})$  and integral molar enthalpy of mixing  $(\Delta_{\text{mix}}H)$  of

#### <span id="page-2-0"></span>TABLE 1

Partial and integral molar enthalpies of mixing of liquid Al–Cu and Al–Sn alloys at 700 C; standard states: pure liquid components.



## <span id="page-3-0"></span>TABLE 1 (continued)



<sup>a</sup> Per mole of binary mixture.

 $\overline{b}$  Average of  $x_i$  before and after the drop.



FIGURE 2. Measured integral enthalpy of mixing in Al–Cu at 973 K with fitted curve and comparison to Hultgren *et al.* [2] and Witusiewicz *et al.* [7].



FIGURE 3. Measured integral enthalpy of mixing in Al-Sn at 973 K with fitted curve and comparison to Hultgren et al. [\[2\].](#page-10-0)

liquid alloys obtained in three separate experiments for Al–Cu and three experiments in Al–Sn at a constant temperature of 973 K are given in [table 1.](#page-2-0) It also provides information to the number of moles of pure metals dropped into the liquid alloys. The lower experimental temperature compared to the ternary system (1273 K, see below) was chosen in order to avoid evaporation of Al. No indica-

tion for significant temperature dependence of both systems was found in literature.

Figure 2 shows the experimental enthalpy of mixing of Al–Cu together with the fitted curve and literature values. Obviously, the values given in the compilation of Hultgren et al. [\[2\]](#page-10-0), which

#### <span id="page-4-0"></span>TABLE 2

Partial and integral enthalpies of mixing of liquid Al–Cu–Sn alloys, 1273 K; standard states: liquid pure components.



TABLE 2 (continued)



(continued on next page)

# TABLE 2 (continued)



### <span id="page-7-0"></span>TABLE 2 (continued)



 $a$  Average value before and after the drop.

are based on calorimetric experiments done by Itagaki and Yazawa [\[4\]](#page-10-0) are much less exotherm than values from our experiments and all other literature data.

[Figure 3](#page-3-0) shows the experimental enthalpy of mixing of Al–Sn together with the fitted curve and literature values. We have measured over the entire concentration range with an overlap along 40 at.%  $\le x_{Al} \le 60$  at.%. The rather consistent literature values and the asymmetry of the enthalpy of mixing curve (with a maximum of approx. 4000 J/mol at 60 at.% Al) could be nicely reproduced.

In the same way, the experimental results for the ternary system Al–Cu–Sn obtained in 10 separate measurements are given in [table 2.](#page-4-0) The starting values of  $\Delta_{\text{mix}}H$  for the binary systems, necessary for the evaluation of the measurements, were taken from this work and literature, see [table 3](#page-8-0). All measured alloy concentrations correspond to the liquid state of the ternary system at 1273 K.

In [figures 4 to 8](#page-8-0) experimental data for all five section  $x_{Al}$  $x_{Cu} = 1:1$  ([figure 4\)](#page-8-0),  $x_{Al}/x_{Sn} = 1:1$  [\(figure 5\)](#page-8-0),  $x_{Cu}/x_{Sn} = 7:3$  ([figure 6\)](#page-8-0),  $x_{\text{Cu}}/x_{\text{Sn}} = 1:1$  ([figure 7\)](#page-8-0), and  $x_{\text{Cu}}/x_{\text{Sn}} = 3:7$  ([figure 8\)](#page-9-0) are shown together with calculated values (see section 3.2). The experimental results of the two runs for each section are in very good agreement to each other, indicating satisfying reproducibility of the measurements. A further proof of the quality of our data is the good agreement of values from different experiments close to the intersection points of the five concentrational sections (see [table 4](#page-9-0) and [figure](#page-1-0) [1](#page-1-0)). The maximum deviation is 500 J/mol, however, it goes down to 50 J/mol and the average deviation is approx. 200 J/mol. Considering the estimated error of  $\pm 150$  J/mol the deviation is insignificant and a chemical systematic error can be thus excluded.

# 3.2. Binary and ternary modeling

The experimental results of the binary systems  $Al + Cu$  and Al + Sn were described by a least square fit to the well-known Redlich–Kister polynomial [\[20\]](#page-10-0) for substitutional solutions which is given by the following equation:

$$
\Delta_{\text{mix}}H = \sum_{i} \sum_{j>i} \left[ x_i x_j \sum_{\nu} {^{\nu} L_{i,j}^{\text{H}} (x_i - x_j)^{\nu}} \right], \tag{4}
$$

#### <span id="page-8-0"></span>TABLE 3







FIGURE 4. Integral molar enthalpies of mixing of liquid Al–Cu–Sn alloys at 1273 K for the section  $x_{Al}/x_{Cu} = 1:1$ ; standard states: pure liquid metals; solid line: calculation with ternary interaction; dashed line: calculation without ternary interaction.



FIGURE 6. Integral molar enthalpies of mixing of liquid Al–Cu–Sn alloys at 1273 K for the section  $x_{Cu}/x_{Sn} = 7:3$ ; standard states: pure liquid metals; solid line: calculation with ternary interaction; dashed line: calculation without ternary interaction.



FIGURE 5. Integral molar enthalpies of mixing of liquid Al–Cu–Sn alloys at 1273 K for the section  $x_{Al}/x_{Sn} = 1:1$ ; standard states: pure liquid metals; solid line: calculation with ternary interaction; dashed line: calculation without ternary interaction.



FIGURE 7. Integral molar enthalpies of mixing of liquid Al–Cu–Sn alloys at 1273 K for the section  $x_{Cu}/x_{Sn} = 1:1$ ; standard states: pure liquid metals; solid line: calculation with ternary interaction; dashed line: calculation without ternary interaction.

<span id="page-9-0"></span>

FIGURE 8. Integral molar enthalpies of mixing of liquid Al–Cu–Sn alloys at 1273 K for the section  $x_{Cu}/x_{Sn} = 3:7$ ; standard states: pure liquid metals; solid line: calculation with ternary interaction; dashed line: calculation without ternary interaction.



FIGURE 9. Iso-enthalpy curves of liquid Al–Cu–Sn alloys at 1273 K; standard states: pure liquid metals. Values in the Cu-corner refer to metastable liquid alloys; all concentrations given in mole fractions.

where *i*, *j*, are equal to element 1 and 2 according to the alphabetical order (Al; Cu and Al; Sn, respectively) and  $v = 0, 1, 2, 3, \ldots$ , etc. up to the maximal necessary power.

The experimental results of the ternary systems Al–Cu–Sn were described by a least square fit to the Redlich–Kister–Muggianu polynomial [\[21\]](#page-10-0) which is given by the following equation:



FIGURE 10. The measured integral molar enthalpies of mixing data derived from KEMS vs. the corresponding calorimetric data at 1273 K.

$$
\Delta_{\text{mix}}H = \sum_{i} \sum_{j>i} \left[ x_i x_j \sum_{v} {}^{v} L_{ij}^{H} (x_i - x_j)^{v} \right] + x_i x_j x_k \left( {}^{(0)} L_{ij,k}^{H} x_i + {}^{(1)} L_{ij,k}^{H} x_j + {}^{(2)} L_{ij,k}^{H} x_k \right),
$$
\n(5)

where  $i, j, k$  are equal to 1, 2, 3 for the element Al, Cu, and Sn and  $v = 0, 1, 2, 3, \ldots$ , etc. up to the maximal necessary power. The binary parameters  ${}^vL_{i,j}$  were determined from experimental enthalpies of mixing from this work (Al–Cu and Al–Sn) and literature (Cu–Sn [\[16\]](#page-10-0)); see also [table 3.](#page-8-0) The three ternary parameters  $L_{i,j,k}^{\rm H}$  were obtained from the experimental enthalpies of mixing from the present investigation. The parameters  $L_{i,j,k}^{\text{H}}$  represent the additional mixing enthalpy due to ternary interactions. All binary and ternary interaction parameters are listed in [table 3](#page-8-0). An isenthalpic plot based on this calculation is shown in figure 9. The ternary system shows an exothermic enthalpy minimum of approx. –18,000 J/mol in the Al–Cu binary and a maximum of approx. 4000 J/mol in the Al–Sn binary system. Alloys at the very Cu-rich corner are not fully liquid at 1273 K and the plotted values have to be considered as an extrapolation to the metastable state.

The calculated values for the enthalpy of mixing in the liquid Al–Cu–Sn system along the sections measured are shown in [figures](#page-3-0) [2 to 6](#page-3-0) as solid lines, together with the experimental results. The calculated values based on the Redlich–Kister–Muggianu polynomial are in excellent agreement with the measured values for all sections. The dashed lines indicate calculated values neglecting the terms for ternary interactions in equation (5). For all section, these values fit much worse to our experiments and are generally too low (more exothermic or less endothermic) in comparison to the experiment. As a conclusion we suppose that in the Al–Cu– Sn system additional, repulsive ternary interaction occur if ternary





 $a$  Rounded to 50 J/mol.

<span id="page-10-0"></span>liquid alloys are formed. This is as well indicated by the three positive ternary interaction parameters; see [table 3](#page-8-0).

## 3.3. Comparison to data obtained from KEMS measurements

The enthalpies of mixing data, obtained in this work, were compared to those obtained by Bencze et al. [1]. The authors of this paper investigated 31 compositions (41 samples) of the Al–Cu–Sn system in the liquid region {1273 to 1473 K} by KEMS. They presented data on excess Gibbs free energy, ternary  $L<sup>G</sup>$ -parameters, activities, activity coefficients, partial equilibrium vapor pressures as well as partial and integral molar excess Gibbs Energy and fitted their data also to the Redlich–Kister–Muggianu model [20], i.e. in the form of equation (6), similar to equation [\(5\):](#page-9-0)

$$
G^{E} = \sum_{i} \sum_{j>i} \left[ x_{i} x_{j} \sum_{v} {}^{v} L_{ij}^{G} (x_{i} - x_{j})^{v} \right] + x_{i} x_{j} x_{k} \left( {}^{(0)} L_{i,j,k}^{G} x_{i} + {}^{(1)} L_{i,j,k}^{G} x_{j} + {}^{(2)} L_{i,j,k}^{G} x_{k} \right),
$$
(6)

where  $G<sup>E</sup>$  denotes the integral molar excess Gibbs energy. The excess Gibbs energy binary  $({}^vL_{i,j}^{\mathsf{G}})$  and ternary  $({}^{(0\,or\,1\,or\,2)}L_{i,j,k}^{\mathsf{G}})$   $L$ parameters certainly differ from the corresponding enthalpy type  $L^{\rm H}$ -parameters  $({}^vL_{i,j}^{\rm H}$  and  ${}^{(0\, or \, 1\, or \, 2)}L_{i,j,k}^{\rm H})$  present in equation [\(5\).](#page-9-0) Though reference [1] did not present the excess enthalpy and entropy data of liquid Al–Cu–Sn alloy, all the excess or mixing data (both partial and integral) of these quantities can be evaluated from the reported ternary  $G^{\rm E}(T)$  functions where the various  $L^{\rm G}(T)$ terms include the temperature dependence. The binary and ternary  $L^{G}(T)$  parameters present in equation (6) are given in the form of  $L^G = A + B + C \cdot T \ln(T)$  in reference [1]. Therefore, using the wellknown Gibbs–Helmholtz equation for the evaluation of  $H^{\rm E}(T)$  from  $G^{E}(T)$ , the following relationships can be obtained:

$$
L_{i,j}^H = A_{i,j} - C_{i,j}T \text{ and } L_{i,j,k}^H = A_{i,j,k} - C_{i,j,k}T.
$$
 (7)

It follows from equation (7) that  $L<sup>H</sup>$  is equal to A if  $C = 0$ , *i.e.* the enthalpy data do not depend on temperature if all the corresponding C parameters in the polynomial are equal to 0. This holds (i.e. all  $C = 0$ ) for the binary Al–Sn data [2,8], for the binary Al–Cu [8] and for the binary Cu–Sn [22]. Nevertheless, according to Flandorfer et al. [16], some of the C-parameters of the binary Cu–Sn system must depend on temperature causing temperature dependence of the integral excess enthalpy. Similarly, the ternary  $L<sup>H</sup>$ -parameters must also depend on temperature according to both this work and reference [1]. The comparison of the ternary  $L^{H}$ -parameters obtained in this work and evaluated from the  $L^{G}(T)$ -functions of reference [1] can be seen in [table 3](#page-8-0) at 1273 K. The last three columns include the data of reference [1]. The agreement between the calorimetric and KEMS enthalpy of mixing data can be seen in [figure 10](#page-9-0) where both the directly measured calorimetric data and also the fitted calorimetric data are plotted against the KEMS data. One can see that the correlation is excellent in both cases but it is even better with the fitted calorimetric data. When comparing the calorimetric enthalpy of mixing data to those obtained by KEMS it should be noted that KEMS determines these data using the 2nd or 3rd law thermodynamic methods, i.e., not directly. Therefore the uncertainty of the KEMS must be higher. The estimated uncertainty of the enthalpy data by KEMS is  $(\sim 1 \text{ to } 2)$  kJ/mol.

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